

N-Channel Reduced Q_g , Fast Switching MOSFET

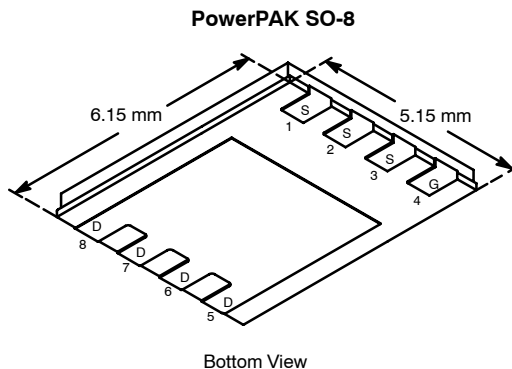
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
30	0.008 @ $V_{GS} = 10$ V	18
	0.011 @ $V_{GS} = 4.5$ V	15

FEATURES

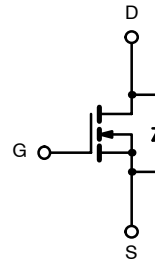
- TrenchFET® Power MOSFET
- PWM Optimized for High Efficiency
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile
- 100% R_g Tested

APPLICATIONS

- Buck Converter
 - High Side or Low Side
- Synchronous Rectifier
 - Secondary Rectifier



Bottom View
Ordering Information: Si7860DP-T1



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C UNLESS OTHERWISE NOTED)					
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	30		V
Gate-Source Voltage		V _{GS}	±20		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	18	11	A
	T _A = 70 °C		15	8	
Pulsed Drain Current		I _{DM}	±50		
Continuous Source Current (Diode Conduction) ^a		I _S	4.1	1.5	
Avalanche Current	L= 0.1 mH	I _{AS}	30		mJ
Single Pulse Avalanche Energy		E _{AS}	45		
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	5	1.8	W
	T _A = 70 °C		3.2	1.1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient (MOSFET) ^a	$t \leq 10$ sec	R_{thJA}	20	25	$^\circ\text{C/W}$
	Steady State		56	70	
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.8	2.3	

Notes

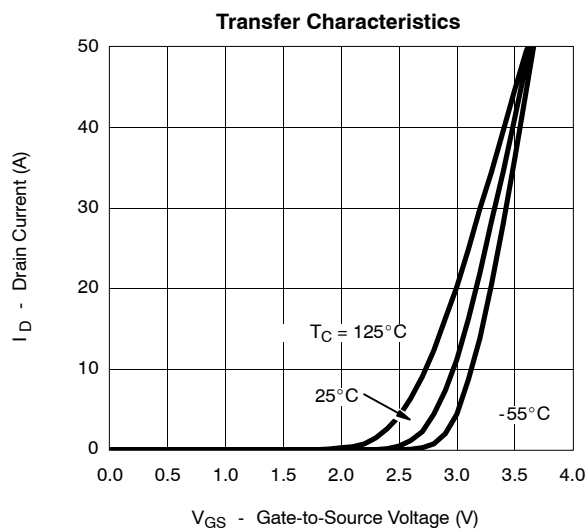
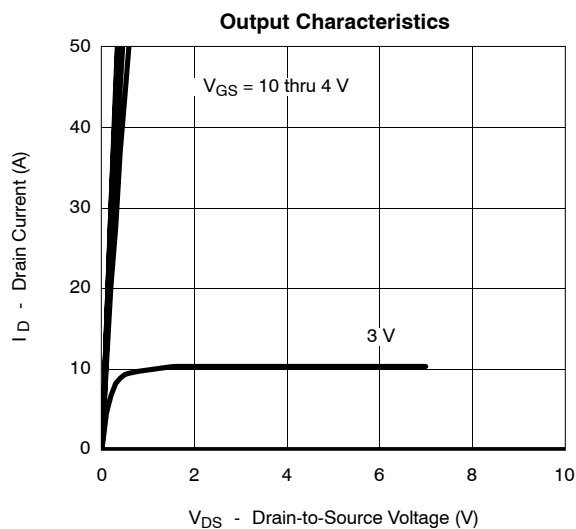
a. Surface Mounted on 1" x 1" FR4 Board.

MOSFET SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

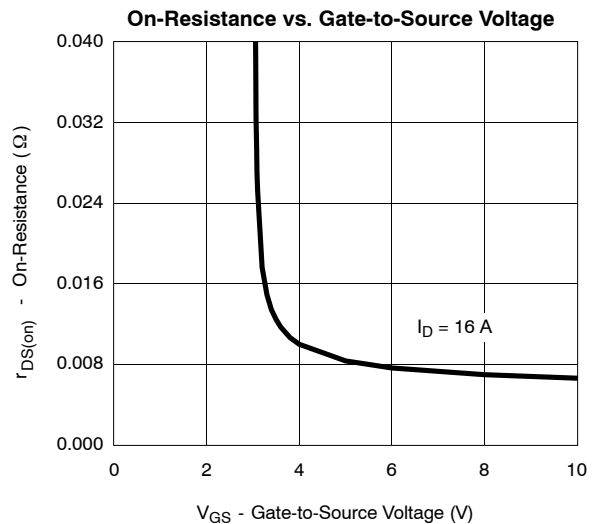
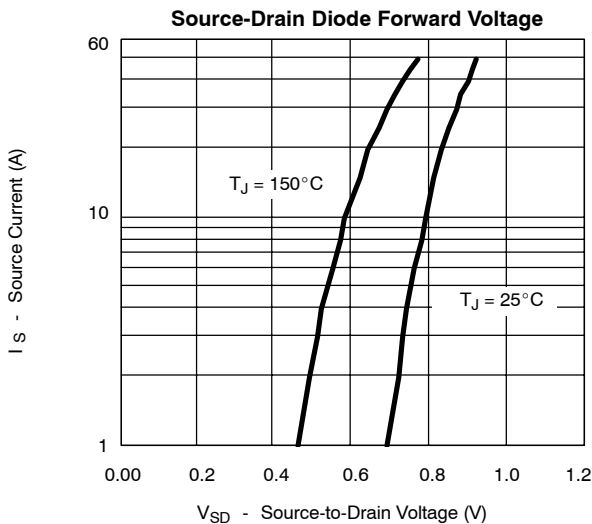
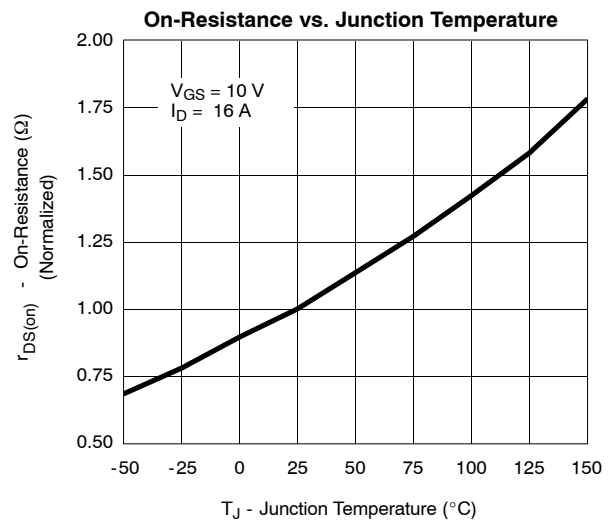
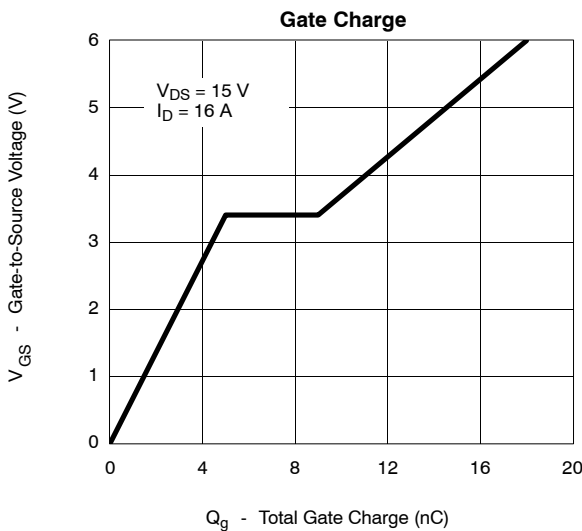
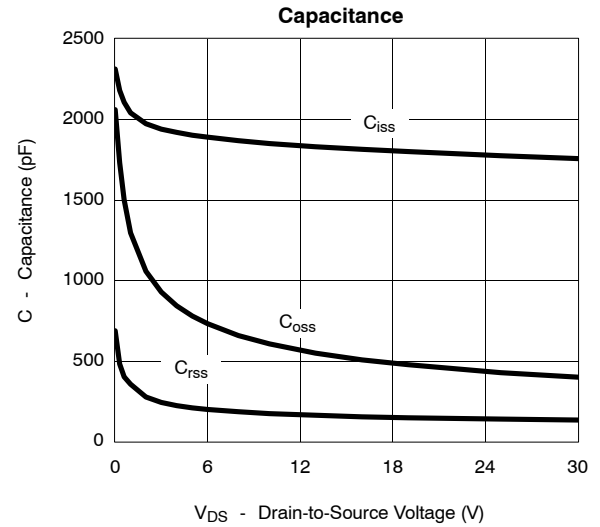
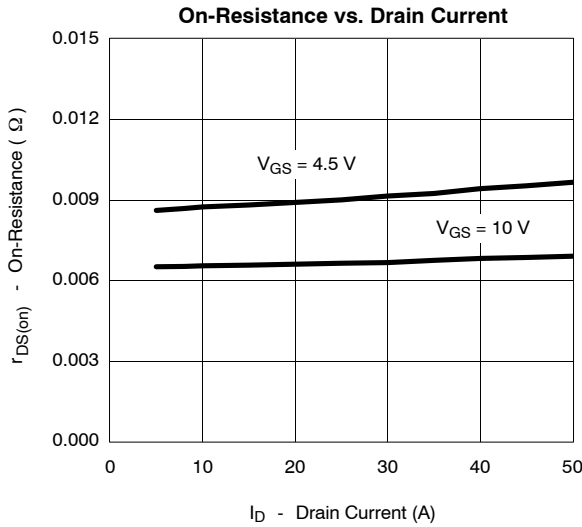
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	1.0		3.0	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 20\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24\ \text{V}$, $V_{GS} = 0\ \text{V}$			1	μA
		$V_{DS} = 24\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 70^\circ\text{C}$			5	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\ \text{V}$, $V_{GS} = 10\ \text{V}$	40			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10\ \text{V}$, $I_D = 18$		0.0066	0.008	Ω
		$V_{GS} = 4.5\ \text{V}$, $I_D = 15$		0.0090	0.011	
Forward Transconductance ^a	g_{fs}	$V_{DS} = 15\ \text{V}$, $I_D = 18$		60		S
Diode Forward Voltage ^a	V_{SD}	$I_S = 3\ \text{A}$, $V_{GS} = 0\ \text{V}$		0.70	1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = 15\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 18\ \text{A}$		13	18	nC
Gate-Source Charge	Q_{gs}			5		
Gate-Drain Charge	Q_{gd}			4.0		
Gate-Resistance	R_g		0.5	1.7	3.2	Ω
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15\ \text{V}$, $R_L = 15\ \Omega$ $I_D \cong 1\ \text{A}$, $V_{GEN} = 10\ \text{V}$, $R_G = 6\ \Omega$		18	27	ns
Rise Time	t_r			12	18	
Turn-Off Delay Time	$t_{d(off)}$			46	70	
Fall Time	t_f			19	30	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = 3\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$		40	70	

Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

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